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Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 4/23/2018
TID #: TIDA-01621	Project Title: Smart Brake Control and Diagnostics Reference Design	Sheet Title: Sheet1
Number: TIDA-01621   Rev: E1	Assembly Variant: [No Variations]	Sheet: 2 of 3
Drawn By: Mega Priya	File: TIDA-01621_BlkSheet_SchDoc	Size: B
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